

2SC5912

Silicon NPN triple diffusion mesa type

Horizontal deflection output for TV

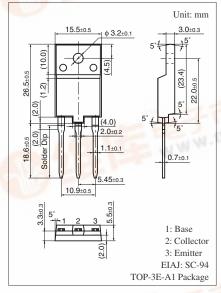
Features

- High breakdown voltage: V_{CBO} ≥ 1500 V
- Wide safe operation area
- Built-in dumper diode

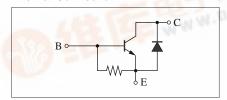
■ Absolute Maximum Ratings $T_C = 25$ °C

| Parameter | | | Unit | | | | | | |
|--|--------------------------|---|--|--|--|--|--|--|--|
| Collector-base voltage (Emitter open) | | | V | | | | | | |
| Collector-emitter voltage (E-B short) | | | V | | | | | | |
| Emitter-base voltage (Collector open) | | | V | | | | | | |
| Base current | | | A | | | | | | |
| Collector current | | | A | | | | | | |
| Peak collector current * | | | A | | | | | | |
| Collector power dissipation | | 40 | W | | | | | | |
| = 25°C | | 3 | | | | | | | |
| Junction temperature | | | °C | | | | | | |
| Storage temperature | | | °C | | | | | | |
| Note) *: Non-repetitive peak collector current | | | | | | | | | |
| | B short) or open) = 25°C | $\begin{array}{c ccccccccccccccccccccccccccccccccccc$ | er open) V_{CBO} 1500 8 short) V_{CES} 1500 or open) V_{EBO} 7 I_{B} 3 I_{C} 10 I_{CP} 15 P_{C} 40 = 25°C 3 T_{j} 150 T_{stg} -55 to +150 | | | | | | |

Note) *: Non-repetitive peak collector current



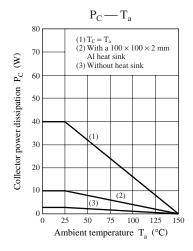
Internal Connection

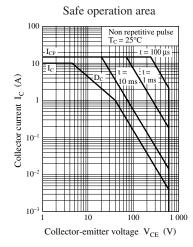


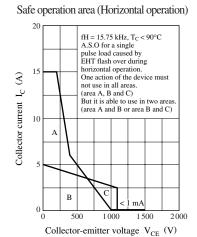
■ Electrical Characteristics $T_C = 25^{\circ}C \pm 3^{\circ}C$

| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|--|----------------------|---|-----|-----|-----|------|
| Emitter-base voltage (Collector open) | V _{EBO} | $I_E = 500 \text{ mA}, I_C = 0$ | 7 | | | V |
| Forward voltage | V _F | I _F = 5 A | | | -2 | V |
| Collector-base cutoff current (Emitter open) | I_{CBO} | $V_{CB} = 1000 \text{ V}, I_{E} = 0$ | | | 50 | μΑ |
| | - | $V_{CB} = 1500 \text{ V}, I_E = 0$ | | | 1 | mA |
| Forward current transfer ratio | h _{FE} | $V_{CE} = 5 \text{ V}, I_{C} = 5 \text{ A}$ | 5 | | 10 | _ |
| Collector-emitter saturation voltage | V _{CE(sat)} | $I_C = 5 \text{ A}, I_B = 1.25 \text{ A}$ | | | 2.5 | V |
| Base-emitter saturation voltage | V _{BE(sat)} | $I_C = 5 \text{ A}, I_B = 1.25 \text{ A}$ | | | 1.5 | V |
| Transition frequency | f_T | $V_{CE} = 10 \text{ V}, I_{C} = 0.1 \text{ A}, f = 0.5 \text{ MHz}$ | | 3 | | MHz |
| Storage time | t _{stg} | I _C = 5 A, Resistance loaded | | | 5.0 | μs |
| Fall time | t _f | $I_{B1} = 1.25 \text{ A}, I_{B2} = -2.5 \text{ A}$ | | | 0.5 | μs |

Sote) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.









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